



National Standards Authority of Ireland

IRISH STANDARD

I.S. EN 160100:1998

ICS 31.180

**SECTIONAL SPECIFICATION: CAPABILITY
APPROVAL OF MANUFACTURERS OF
PRINTED BOARD ASSEMBLIES OF
ASSESSED QUALITY**

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Descriptors: Printed board assemblies, quality assessment, capability approval, test, measurement procedures

English version

**Sectional Specification:
Capability approval of manufacturers of
printed board assemblies of assessed quality**

**Rahmenspezifikation:
Befähigungsanerkennung für Hersteller
von bestückten Leiterplatten mit
bewerteter Qualität**

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CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

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